

Overview

HP Elite x360 1040 14 inch G10 2-in-1 Notebook PC



- 1. Internal Microphones (2)
- 2. Ambient Light Sensor (Optional)
- 3. Webcam
- 4. Camera Shutter
- 5 IR Camera
- 6. IR Camera LEDs
- 7. ToF (Time of Flight) sensor
- 8. NFC Sensor
- 1. SuperSpeed USB 20Gbps is not available with Thunderbolt $^{\text{TM}}$ 4.

Left

- 9. Glass Clickpad
- 10. Smartcard Reader (Optional)
- 11. LED Indicator
- **12.** ThunderboltTM 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4)¹
- **13.** ThunderboltTM 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4)¹
- **14.** SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1)
- 15. HDMI 2.1 Port (Cable not included)

Overview



Right

- 1. Power Button Key
- 2. Audio Combo Jack
- **3.** SuperSpeed USB Type-A 5Gbps signaling rate (Charging) (USB 3.2 Gen 1)
- 4. Nano Security Lock Slot (Lock sold separately)
- 5. SIM Card Slot (Optional)
- **6.** Touch Fingerprint Sensor (Select models)

Overview



Overview

At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- 13th generation Intel® processor, up to Core[™] i7 with optional vPro®
- x360 ultraslim design with precision-crafted magnesium chassis for a premium look and feel
- LPDDR5 memory (up to 32GB) and PCI Gen4 SSDs provide fast access and more efficiency to your work
- 16:10 aspect ratio panel with HP Eye Ease blue light reduction option
- An optional HP Rechargeable Active Pen G3 with Magnetic Attach and 4096 Levels of pressure
- 5MP camera with HP Auto Frame allows you around a little without losing viewers' attention during video calls
- Choose from 38Wh or 51Wh battery options
- Bluetooth® 5.3 with lower power consumption, less interference and better security
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense
- Larger clickpad surface for easier, more intuitive input
- Connectivity with optional Intel® 5000 5G/WWAN, and ThunderboltTM Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests1
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5
- Can be wiped up to 1000 times with common household cleaning wipes²
- 1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 2. Select household wipes can be safely used. See wipe manufacturer's instructions for disinfecting and the HP cleaning guide for HP tested wipe solutions at How to Sanitize Your HP Device Whitepaper http://h20195.www.2.hp.com/v2/GetDocument.aspx? docname=4AA7-7610ENW

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP Elite x360 1040 14 inch G10 2-in-1 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 11 Pro ¹

Windows 11 Pro Education ¹

Windows 11 Home - HP recommends Windows 11 Pro for Business¹

Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business 1

Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing

Agreement) 1

Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) 1,2

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchase hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated ar enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions v require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor 3,4,5,6,7	Cores	Number Number ores of of		Threads L3	L3	Max Turbo Frequency		Base Frequency		Intel SIPP/vPro® Enterprise	Intel vPro® Essentials
3,4,3,0,1		P-cores	E-cores		Cache	P-	E-	P-	E-	•	
						cores	cores	cores	cores		
Intel® Core TM	10	2	8	12	12 MB	5.2	3.9	1.8	1.3	x	
i7-1365U	10			12	12 12 110	GHz	GHz	GHz	GHz	^	
Intel® Core TM	10	2	8	12	12 MB	5.0	3.7	1.7	1.2		
i7-1355U	10		0	12	12 110	GHz	GHz	GHz	GHz		
Intel® Core TM	10	2	8	12	12 MB	4.7	3.5	1.6	1.0	x	
i5-1345U	10		0	12	. 12 1410	GHz	GHz	GHz	GHz	^	
Intel® Core TM	10	2	8	12	12 MD	4.6	3.4	1.3	0.9		
i5-1335U	10	4	0	12 12 MB	12 12	GHz	GHz	GHz	GHz		

^{3.} Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

^{4.} Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode. 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

^{6.} In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on proc configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com

Technical Specifications

7. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wirec LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® X? Graphics 8

Supports

Support HD decode, DX12, HDMI 2.1, HDCP 2.3 9

8. Intel® Iris® X? Graphics capabilities require system to be configured with Intel® CoreTM i5 or i7 processors and dual channel memory. Intel® Iris® X? Graphics with Intel® CoreTM i5 or 7 processors and single channel memory will only function as UHD graphics.

9. HDMI cable sold separately

DISPLAY

Touch

35.6 cm (14") diagonal WUXGA Bent touch screen , BrightView UWVA, eDP, 250 nits, 45% NTSC, time of flight sensor, with 5MP+II camera (1920 x 1200) 10,11,13

35.6 cm (14") diagonal WUXGA Bent touch screen, BrightView UWVA, eDP, 250 nits, 45% NTSC, time of flight sensor, with 5MP+II camera for WWAN(1920 x 1200) 10,11,13

35.6 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Power Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN with HP Eye Ease (1920 x 120 10,11,13

35.6 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.4+PSR, 400 nits, 100% sRGB, Low Pow Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN with HP Eye Ease (1920 x 120 10.11.13

35.6 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera with HP Eye Ease (1920 x 1200) 10,11,12,13

35.6 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN with HP Eye Ease (1920 x 1200) 10,11,12,13

35.6 cm (14") diagonal WUXGA Bent touch screen, Low Blue Light, BrightView UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN with HP Eye Ease (1920 x 1200) 10,11,12,13

35.6 cm (14") diagonal WQXGA Bent touch screen, Bright View UWVA, 500 nits, eDP 1.4+PSR2, Ambient Light Sensor+ Ambient Consor, time of flight sensor, with 5MP+IR Camera for WWAN (2560 x 1600) 10,11,13

DisplayPortTM 1.4

HDMI 2.1 Support resolution up to 4K @60 Hz 9

Displays support

Supports dual display through the dock

Display Size (Diagonal)

Technical Specifications

14" diagonal 35.6 cm (14"?) diagonal

- 9. HDMI cable sold separately
- 10. HD content required to view HD images.
- 11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 12. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 13. Actual brightness will be lower with touchscreen or Sure View.

DOCKING (Sold Separately)

Docking station model #1 HP Thunderbolt 120W G4 Dock

Docking station model #2 HP Thunderbolt 280W G4 Dock

Docking station model #3 HP USB-C Dock G5

Docking station model #4HP USB-C/A Universal Dock G2Docking station model #5HP USB-C G5 Essential DockFor additional aftermarket options and docking specs please see page 42.

STORAGE AND DRIVES

Primary Storage

2TB 2280 PCIe-4x4 NVMe Three Layer Cell Solid State Drive ¹⁴
1TB 2280 PCIe-4x4 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive ¹⁴
1TB 2280 PCIe4x4 NVMe Three Layer Cell SSD ¹⁴
512GB 2280 PCIe-4x4 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive ¹⁴
512GB PCIe-4x4 NVMe Three Layer Cell Solid State Drive ¹⁴
512GB 2280 PCIe NVMe Value ¹⁴
256GB 2280 PCIe NVMe Self Encrypted OPAL2 Value Solid State Drive ¹⁴
256GB 2280 PCIe NVMe Value ¹⁴

14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 at 11) is reserved for system recovery software.

MEMORY

Technical Specifications

Maximum Memory

32 GB LPDDR5-4800 SDRAM 15

Memory

32 GB LPDDR5-4800 SDRAM¹⁵ 16 GB LPDDR5-4800 SDRAM¹⁵ 8 GB LPDDR5-4800 SDRAM¹⁵

Memory Slots

Supports Dual-channel Memory Memory Soldered Down (customers non-accessible / non-upgradeable) System runs at 4800

15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensucompatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi6E+ Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN vPro Wireless Card ¹⁶
Intel® AX211 Wi-Fi6E+ Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN non-vPro Wireless Card ¹⁶

WWAN

Intel® 5000 5G Solution WWAN ^{17,18}
Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) ¹⁷

NFC

Near Field Communication (NFC) module ¹⁹
HP Module with NXP NFC Controller NPC300 I2C NCI

Miracast

Native Miracast Support 20

16. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

17. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Chec with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, netwo conditions, and other factors. 4G LTE not available on all products, in all regions.

18. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR an LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds wi vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSP technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

19. Sold separately or as an optional feature.

20. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Technical Specifications

Audio

Audio by Bang & Olufsen 2 Integrated stereo speakers Integrated dual array microphone Discrete Amplifiers

Speaker Power

1W/8ohm Per speaker

Camera

5 MP+IR camera ²¹

5 MP + IR camera for face authentication with Windows Hello

Sensors

ALS (ambient light sensor) ToF (Time of Flight) sensor Magnetometer Hall Sensor Gyro Accelerometer HP Tamper Lock ²²

21. Sold separately or as an optional feature.

22. HP Tamper Lock must be enabled by the customer or your administrator.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys

Pointing Device

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

home

end

Power Button (with LED)

Delete

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock



Technical Specifications

SOFTWARE AND SECURITY

Preinstalled Software

Software

HP Easy Clean 23

HP PC Hardware Diagnostics Windows

mvHP

HP Smart Support 24

HP Services Scan 25

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant ²⁶

HP Notifications

HP Privacy Settings

HP Power Manager²⁷

Microsoft Office sold separately and requires Internet access for activation

Manageability Features

HP Connect 28

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) 29

HP Client Management Script Library (download)

HP Patch Assistant (download) 30

HP Driver Packs (download)

HP Client Catalog (download)

HP Cloud Recovery 31

Security Management

HP Wolf Security for Business 32 includes:

HP Sure Click 33

HP Sure Sense 34

HP Sure Run 35

HP Sure Recover 36

HP Sure Start 37

HP Tamper Lock 38

HP Sure Admin 39

BIOS

HP BIOSphere Gen6 40

HP Secure Erase 41

Absolute Persistence Module 42

BIOS Update via Network

HP Wake on WLAN

Secured-Core PC Enable 43

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

HP Fingerprint Sensor 44

Security

TPM

Model: Nuvoton NPCT760HABYX

Version: 7.2.3.1 Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Support

Technical Specifications

Yes

FirstNet Certified

Yes

The BIOS on this notebook implements ISO/IEC 19678:2015 guidelines (formerly NIST 800-147).

UEFI version: 2.7

Class: 3

23. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are no disabled. See user guide for cleaning instructions.

24. HP Smart Support requires HP TechPulse to be installed. For more information about how to enable or to download HP Smart Support, please visit http://www.hp.com/smart-support.

25.HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements. Not applicable in China.

26. HP Support Assistance requires Windows and Internet Access

27. HP Power Manager requires Windows 10 and higher and can be downloaded from the Microsoft Store.

28. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

29. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.htm

30. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Cent Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

- 31. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoloss of data. Details please refer to: https://support.hp.com/us-en/document/c05115630.
- 32. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro Elite, RPOS and Workstation products. See product details for included security features and OS requirement.
- 33. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.lv/2PrLT6A SureClick for complete details.
- 34. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS
- 35. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.
- 36. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module
- 37. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher
- 38. HP Tamper Lock must be enabled by the customer or your administrator.
- 39. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store

- 40. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
- 41. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® OptaneTM.
- 42. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, ch with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/
- 43. Secured-Core PC Enable requires an Intel® vPro®, AMD RyzenTM Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.
- 44. HP Fingerprint sensor is an optional feature that must be configured at purchase.

POWER

Technical Specifications

Power Supply

HP Smart 65 W USB Type-C[®] adapter ⁴⁵ HP Smart 65 W Slim USB Type-C[®] adapter ⁴⁵

Battery

HP Long Life 3-cell, 38 Wh Polymer ^{46,47} HP Long Life 3-cell, 51 Wh Polymer ^{46,47} Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m ⁴⁵ 2-wire plug - 1m ⁴⁵

Battery Life

Up to 14 hours 45 mins (U15, HP Long Life 3-cell, 51 Wh Li-ion Polymer, UMA graphic, display set to 200nits, 16GB LPDDR5 memc 512GB NVMe SSD) 48

Up to 10 hours 30 mins (U15, HP Long Life 3-cell, 38 Wh Li-ion Polymer, UMA graphic, display set to 200nits, 16GB LPDDR5 memc 512GB NVMe SSD)⁴⁸

- 45. Availability may vary by country.
- 46. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 47. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
 48. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight- 38 Whr 49

Starting at 2.94 lb Starting at 1.33 kg

Product Dimensions (W x D x H)

12.43 x 8.89 x 0.75 in 31.56 x 22.58 x 1.92 cm

Packaging Dimensions (W \times D \times H) 50

12-15"? boxes (305mm height): 1200mm x 1000mm x 1080mm

- 49. Weight will vary by configuration. Does not include power adapter.
- 50. Product packaging size varies based on options chosen. Please contact your HP representative for your packaging size details

PORTS/SLOTS

Technical Specifications

2 ThunderboltTM 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4) ⁵¹

2 Super Speed USB Type-A 5Gbps signaling rate (1 charging) (USB 3.2 Gen 1)

1 HDMI 2.1 9

1 Headphone/microphone combo jack

1 Nano Security Lock Slot (Lock sold separately)

1 Smartcard reader (Optional)

1 nano SIM card slot (Optional)

51. SuperSpeed USB 20Gbps is not available with ThunderboltTM 4.

9. HDMI cable sold separately '.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is als available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc

52. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicate Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

SYSTEM UNIT

Stand-Alone Power Requirements Type-C® Adapter

(AC Power)

Nominal Operating Voltage AC 20V

Average Operating Power

Integrated graphics Yes
Discrete Graphics N/A
Max Operating Power 65W

Temperature

Operating 32° to 95° F (0° to 35° C)

(No sustained direct exposure to sunlight)

(System performance may be reduced above 32°C (89.6°F))

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90% (non-condensing)

Non-operating 5% to 95%

(38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)

Shock

Operating 40 G, 2 ms, half-sine Non-operating 240 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grams

Technical Specifications

Non-operating 3.5 grams

Altitude (unpressurized)

Operating 10,000 ft (3,048 m) Non-operating 40,000 ft (12,192 m)

Planned Industry Standard

Certifications

Regulatory Model Number HSN-I45C CSA/UL 62368-1 Yes **ENERGY STAR®** Yes 53

EPEAT® EPEAT® Gold in the United States 54

FCC/ICES/CISPR/VCCI Yes **CE MARKING** Yes **GS Mark**

Related commodity should comply with ISO 9241 Standards.

China CCC/SRRC Yes Taiwan BSMI/NCC Yes Korea KCC/KC/KES Yes Ukraine NSoC/TEC Yes **EAEU Compliance** Yes Saudi Arabian Compliance Yes TCO Yes Low Blue Light Yes WW RoHS Yes

53. Configurations of the HP Elite x360 1040 14 inch G10 2-in-1 Notebook PC that are ENERGY STAR® qualified are identified as HP Elite x360 1040 14 inch G10 2-in-1 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov. 54. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

1. Actual brightness will be lower with touchscreen or HP Sure View.

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

300 (max)

Anti-Glare UWVA LED NTSC NB2X 250 eDP 1.2 w/o PSR 45 bent LCD Panel

14.0 in WUXGA (1920 x 1200) Outline Dimensions (W x H x D) 307.590 x 199.550 (max) **Active Area** 301.590 x 188.500 (tvp)

> Weight Diagonal Size 14 **Surface Treatment** Anti-Glare

Touch Enabled No **Contrast Ratio** 1000:1(typ) 60 Hz

Refresh Rate 250 nits1 **Brightness**

Pixel Resolution - Format 1920 x 1200 (WUXGA)

Backlight WLED Pixel Resolution RGB NTSC 45% Color Gamut Coverage

Color Depth

Viewing Angle UWVA 89/89/89/89

Technical Specifications

Low Blue Light

Power Consumption (W. EBL@ 150nits max/ 200nits max)

No

2.20 (max) / 2.70 (max)

Anti-Glare UWVA WLED+LBL Active Area sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

14.0 in WUXGA (1920 x 1200) Outline Dimensions (W x H x D)

307.590 x 199.550 (max) 301.590 x 188.500 (typ) Weight 210 (max)

Diagonal Size 14 **Surface Treatment** Anti-Glare **Touch Enabled** No

Contrast Ratio 1000:1(typ) **Refresh Rate** 60 Hz 400 nits1 **Brightness**

Pixel Resolution - Format 1920 x 1200 (WUXGA)

Backlight WLED **Pixel Resolution** RGB **Color Gamut Coverage** sRGB 100%

Color Depth 8

Viewing Angle UWVA 89/89/89/89

Low Blue Light

Power Consumption (W, EBL@ 1.29 (max) / 1.66 (max) 150nits max/ 200nits max)

14.0 in WUXGA (1920 x 1200) Outline Dimensions (W x H x D) Anti-Glare UWVA WLED+LBL Active Area sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel

307.600 x 199.550 (max) 301.680 x 188.500 (typ)

Weight 238 (max) Diagonal Size 14

Surface Treatment Anti-Glare **Touch Enabled** No

Contrast Ratio 1500:1 (typ) **Refresh Rate** 60 Hz 1000 nits1 **Brightness**

Pixel Resolution - Format 1920 x1200 (WUXGA)

Backlight WLED **Pixel Resolution RGB Color Gamut Coverage** sRGB 100%

Color Depth

UWVA 85/85/85/85 **Viewing Angle**

Low Blue Light Yes Power Consumption (W, EBL@ N/A 150nits max/ 200nits max)

Technical Specifications

14.0 in WQXGA (2560 x 1600) Anti-Glare UWVA LED DCI-P3 NB2X 500 eDP 1.4+PSR2 100 120Hz bent LCD Panel

 Outline Dimensions (W x H x D)
 307.594 x 199.546 (max)

 Active Area
 301.594 x 188.496 (typ)

14

Weight 230 (max)

Surface Treatment Anti-Glare

Touch Enabled No

Diagonal Size

Contrast Ratio1200:1(typ)Refresh Rate120 HzBrightness500 nits1

Pixel Resolution - Format 2560 x1600 (WQXGA)

Backlight WLED
Pixel Resolution RGB

Color Gamut Coverage DCI-P3 100%

Color Depth 8

Viewing Angle UWVA 89/89/89

Low Blue Light No

Power Consumption (W, EBL@ 2.88 (max) / 3.44 (max) 150nits max/ 200nits max)

STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 3500 MB/s ±20%

 Logical Blocks
 1,000,215,215

 Features
 Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell

Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks2,000,409,264FeaturesPyrite 2.0; TRIM; L1.2

Technical Specifications

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity2TBNAND TypeTLC

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 4,000,797,360

 Features
 Pyrite 2.0; TRIM; L1.2

256GB PCIe 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive

Capacity 256GB **NAND Type** TLC

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 2000 MB/s ±20%

 Maximum Sequential Write
 900 MB/s ±20%

 Logical Blocks
 500,118,192

 Features
 TCG Opal 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive

NAND Type TLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write3500 MB/s ±20%Logical Blocks1,000,215,215

Features TCG Opal 2.0; TRIM; L1.2

1TB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive

NAND Type TLC
Interface PCIe

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

 Logical Blocks
 2,000,409,264

Features TCG Opal 2.0; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value

NAND Type TLC

Features

InterfacePCIe NVMe Gen4X4Maximum Sequential Read2000 MB/s ±20%Maximum Sequential Write900 MB/s ±20%Logical Blocks500,118,192

Pyrite 2.0; TRIM; L1.2

Technical Specifications

SSD 512GB 2280 PCIe NVMe Value

NAND Type TLC

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 2200 MB/s ±20%

 Maximum Sequential Write Logical Blocks
 1,000,215,215

 Features
 Pyrite 2 0: TRIM: I 1

Features Pyrite 2.0; TRIM; L1.2
NAND Type TLC

NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E +Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN vPro Wireless Card¹ **Wireless LAN Standards**

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r

Interoperability

Frequency Band

IEEE 802.11v Wi-Fi certified

• 802.11b/g/n/ax

2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac : 1733Mbps802.11ax : max 2.4Gbps

Modulation

Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security²

IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

Technical Specifications

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power³802.11b: +17dBm minimum
802.11g: +16dBm minimum
802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum

802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8q

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

LED Activity

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m) LED Amber - Radio OFF; LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Technical Specifications

Number of Available Channels Data Rates and Throughput

Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designe support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN non-vPro Wireless Card¹ **Wireless LAN Standards**

IEEE 802.11a IEEE 802.11b

IEEE 802.11g

IEEE 802.11n IEEE 802.11ac

IEEE 802.11ax

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability

Frequency Band

Wi-Fi certified

802.11b/g/n/ax
 2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz

5.47 - 5.725 GHz

5.825 - 5.850 GHz

5.955 - 6.415 GHz

6.435 - 6.515 GHz

6.535 - 6.875 GHz

6.895 - 7.115 GHz

● 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps

802.11ac : 1733Mbps

802.11ax : max 2.4Gbps

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security 2 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

Technical Specifications

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power 3 802.11b: +17dBm minimum

802.11g: +16dBm minimum 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity 4 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum

802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

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Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

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Weight 1. Type 2230: 2.8g

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)

> Operating 0 to 10,000 ft (3,048 m)

Altitude Non-operating 0 to 50,000 ft (15,240 m)

Technical Specifications

LED Activity LED Amber - Radio OFF: LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) Channels BLE: 0~39 (2 MHz/CH)

Data Rates and Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps Throughput BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designe support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® 5G Solution 5000 1 Technology/Operating bands

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL)

Technical Specifications

Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 48: 3550 to 3700 MHZ (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

5GNR Sub 6GHZ

n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

n38: 2570 to 2620 MHz (UL/DL) n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n48: 3550 to 3700 MHZ (UL/DL)

n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)

Wireless protocol standards

5GNR Air Interface 3GPP Rel15 5G NR sub-6

LTE Rel14

20 layers and 2 Gbps downlink (DL) throughput - 4 × 4 MIMO across 5x

CA

200 Mbps/uplink (UL) throughput - 40 MHz ULCA and 256 QAM

WCDMA R99,

3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

GPS bands GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)

Maximum data rates SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps

5G NSA sub 6G: DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL: 1.6 Gbps) ue-CategoryUL 18, (UL: 211Mbps)

DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm

NR: 23 dBm in all band except n41, n77, n78 and n79

LTE n41, n77, n78 and n79 HPUE = 26dBm

HSPA+: 23.5 dBm 5G Sub 6 : 2500 mA

LTE: 1,300 mA (peak); 1100 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3052-S3 Key B

Weight 8 q

Maximum power consumption

Dimensions ___

(Length x Width x Thickness) 52 mm × 30 mm × 2.3 mm

embedded eSIM Support

^{1. 5}G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module designed for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 5G not available on all products, in all regions.

Technical Specifications

Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select countries, where carrier supported.

Intel® XMMTM 7560 R+ LTE- Technology/Operating Advanced Pro 1

bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30).

1700/2100 (Band 66), 600 (band 71).

TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200

(Band 46 RX only) MHz;

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 12 LTE Specification DL-CAT.16. DL 100MHz BW throughput

up to 978Mbps: UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz

Maximum data rates LTE: 978 Mbps (Download), 150 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2. 3042-S3 Kev B

Weight

Dimensions (Length x Width x Thickness)

42 x 30 x 2.3 mm

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location. environment, network conditions, and other factors, 4G LTE not available on all products or in all countries.

Technical Specifications

NFC Mirage module (NXP NPC300 I2C 10mmx17mm) Dimensions (L x W x H) Module 25 mm by 10 mm by 2.0 mm

Chipset **NPC300 System interface** 120

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode(1) ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-

ISO/IEC 14443 A VICC) Mode(1) ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature 0°C to 70°C Storage temperature -20°C to 125°C **Humidity** 10-90% operating

5-95% non-operating

Supply Operating voltage 4.35 to 5.25 Volts I/O Voltage 1.8V or 3.3V

Power Consumption (Booster enable, VBAT= 3.3V, $VCC_BOOST = 5V$)

Mode Power Consumption, Typical

Polling 7.3 mA

Total 283.8 mA Detected Test Tag Type 1

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

Technical Specifications

AC Adapter 65 Watt nPFC Standard USB Type C® Straight 1.8m

Dimensions (H x W x D)

Weight 0.53 lb (240 g) max

(Not including power cord. Power cord varies by country.)

3.543 x 2.008 x 1.122 in (9.0 x 5.1 x 2.85 cm)

Input 100-240Vac

> **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

> > load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88.0% 15V:89.0% 20V:89.0%

Input frequency range 47-63Hz

Input AC current Max. 1.6 A at 90 Vac

Output power 5V/15W

> 9V/27W 12V/60W 15V/65W 20V/65W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input

Output current limit < 8.0A

Connector USB Type-C®

Environmental Design Operating

32°F to 95°F (0°to 35°C) temperature

Non-operating (storage)

temperature

Altitude

-4°F to 185°F (-20°to 85°C)

0 to 16,400 ft (0 to 5000m) **Humidity** 20% to 95%

Storage Humidity 10% to 95%

EMI and Safety Certifications

Output

CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368

1:2014+A11. UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC

Technical Specifications

HP 65W Slim USB-C® Dimensi Straight AC Power Adapter Weight

Dimensions (H x W x D)

Output

eight 0.49 lb (220 g) max

(Not including power cord. Power cord varies by country.)

3.819 x 2.106 x 0.827 in (9.7x5.35x2.1cm)

Input 100-240Vac

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88.0% 15V:89.0% 20V:89.0%

Input frequency range 47-63Hz

Input AC current Max. 1.6 A at 90 Vac

Output power 5V/15W

9V/27W 12V/60W 15V/65W 20V/65W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input

Output current limit < 8.0A

Connector USB TYPE C®

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368

1:2014+A11, UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC

Technical Specifications

HP 3-cell Long Life Li-Ion (WQ 38Wh)1

Weight 0.178kg +/- 10g(0.392lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 604975

Energy **Voltage** 11.55V

> Amp-hour capacity 3.291Ah Watt-hour capacity¹ 38Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

> Operating (Discharging) 14° to 140° F (-10° to 60° C)

Optional Travel Battery

Available

No

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

HP 3-cell Long Life Li-Ion (51 Wh)¹

Weight

0.229kg +/- 10g (0.505 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 566075

Energy Voltage 11.58V

> **Amp-hour capacity** 4.431Ah Watt-hour capacity¹ 51.3Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

> **Operating (Discharging)** 14° to 140° F (-10° to 60° C)

> > No

Optional Travel Battery

Available

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AUDIO

HD Stereo Codec Realtek ALC3315

Audio I/O Ports Headset: CTIA only and Headphone-out

Internal Speaker Amplifier Cirrus Logic High-Efficiency Boosted Class D Amplifier

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow

independent audio. Following MSFT Behaviour

Sampling DAC:48kHz

ADC:48kHz

Wavetable Syntheses

Analog Audio Support 3.5mm Headset: CTIA only and Headphone-out

of Channels on Line-Out N/A Internal Speaker Yes

FINGERPRINT READER

Technical Specifications

Sensor vendor Main source : Synaptics FS7605

2nd source: ELAN 80SW

Sensor type Capacitive

DPI resolutionMain source : 363 DPI
2nd source : 508 DPI

Scan area Main source : 104 x 86 pixels 2nd source : 80x80 pixels

False Rejection Rate FRR=? 3%

False Acceptance RateMain source : FAR 1/100K
2nd source : < 0.001%</th>Mobile Voltage OperationMain source : 3.0V to 3.6V
2nd source : 2.7V~3.6V

Operating Temperature

Main source : 0°C~60°C
2nd source : -20°C - +80°C

Main source : 100mA max

Low Latency Wait For Finger 2nd source : 35mA peak Main source : 260uA

2nd source : 300uA

Capture Rate Main source : Image transmitter output frequency 9.6MHz

2nd source : 50 frame/sec IEC 61000-4-2 4B (+15KV)

Detection Matrix Main source: 363 dpi / 7.4x6mm sensor area

2nd source: 508 dpi / 4x4mm sensor area

ENVIRONMENTAL DATA

Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook"?.		
Sustainable Impact Specifications	 Ocean-bound plastic in Speaker 45% post-consumer recycled plastic 85% recycled metal Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available 		
Eco-Label Certifications & declarations	labeled with one or more of these marks: IT ECO declaration US ENERGY STAR® US Federal Energy Management Program (FEMP) EPEAT? Gold registered in the United States. See http://www.epeat.net for registration status in your country. TCO Certified China Energy Conservation Program (CECP) China State Environmental Protection Administration (SEPA) Taiwan Green Mark Korea Eco-label Japan PC Green label*		

Normal Operation (Sort idle)	4.83 W	5.13 W	4.97 W
Normal Operation (Long idle)	1.11 W	1.2 W	1.33 W
Sleep	1.11 W	1.2 W	1.33 W
Off	0.43 W	0.47 W	0.43 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short			
idle)	16.5 BTU/hr	17.5 BTU/hr	17.0 BTU/hr
Normal Operation (Long			
idle)	3.8 BTU/hr	4.1 BTU/hr	4.5 BTU/hr
Sleep	3.8 BTU/hr	4.1 BTU/hr	4.5 BTU/hr
Off	1.5 BTU/hr	1.6 BTU/hr	1.5 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions	Sound Power	Sound Pressure
(in accordance with	(L _{WAd} , bels)	(L _{pAm} , decibels)
ISO 7779 and ISO 9296)		
Typically Configured - Idle	2.6	14.3
Fixed Disk - Random writes	3.2	27.0
Optical Drive - Sequential	4.0	32.0
reads		

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5"? years after the end of production.

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 92.9% recycle-able when properly disposed of at end of life.

Packaging Materials	External:	PAPER/Corrugated	220 g
		PAPER/Corrugated	49 g
		PAPER/Molded Pulp	52 g
		PAPER/Molded Pulp	56 g

Technical Specifications

		PAPER/Paper		3 g
	Internal:	PLASTIC/Polyethylene low density -	LDPE	13 g
		ckaging material contains at least 0.0%		
		d paper packaging materials contains at		-
RoHS Compliance	extend the restri (RoHS) Directive development of We believe the fivide elimination substances-inclupertains to elect We met our volu requirements for scope of the cor evolve.	es fully with materials regulations. We witctions in the European Union (EU) Rese to our products worldwide through the related legislation in Europe, as well as RoHS directive and similar laws play an of substances of concern. We have sujuding PVC, BFRs, and certain phthalate trical and electronics products. Juntary objective to achieve worldwide concern virtually all relevant products by July 20 mmitment to include further restricted support of the product of the	etriction of Haze HP GSE. HP China, India, a important role pported the inces-in future Roundle with 013, and we wubstances as	ardous Substances has contributed to the and Vietnam. e in promoting industry- clusion of additional oHS legislation that the new EU RoHS vill continue to extend the regulations continue to
Material Usage	This product doe the HP General S	y of the HP RoHS Compliance Stateme is not contain any of the following substar pecification for the Environment at om/hpinfo/globalcitizenship/environmen	nces in excess (of regulatory limits (refer t
Packaging Usage	Cadmium Chlorinate Chlorinate Bis(2-Ethy Benzyl but Dibutyl phi Diisobutyl Formaldeh Halogenate Lead carbo Lead and L Mercuric O Nickel - fin carried by Ozone Dep Polybromi Polybromi Polychlorir Polychlorir Polyvinyl C voluntarily Radioactiv Tributyl Tii	ed Hydrocarbons d Paraffins lhexyl) phthalate (DEHP) cyl phthalate (BBP) thalate (DBP) phthalate (DIBP) phthalate (DIBP) nyde ed Diphenyl Methanes chates and sulfates lead compounds lixide Batteries lishes must not be used on the external su the user. cleting Substances nated Biphenyl (PBBs) nated Biphenyl Ethers (PBBEs) nated Biphenyl Oxides (PBBOs) nated Biphenyl (PCB) nated Terphenyls (PCT) Chloride (PVC) - except for wires and cable of removed from most applications. The Substances of CTBT), Triphenyl Tin (TPT), Tributyl Tin C	ırface designed s, and certain r Oxide (TBTO)	to be frequently handled etail packaging has been
Packaging Usage	• Eliminate t materials.	e guidelines to decrease the environment the use of heavy metals such as lead, chro the use of ozone-depleting substances (OI	omium, mercur	y and cadmium in packagii
		ckaging materials for ease of disassembly.		<u> </u>

Technical Specifications

End-of-life Management and Recycling	 Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:
	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded.
	 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. Plastic cushions are made from >90% recycled plastic.\ Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

COUNTRY OF ORIGIN

China

Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

Docking station model #1

Total number of supported displays (incl. the notebook display)

Max. resolutions supported

Dock Connectors
Technical limitations

Docking station model #2

Total number of supported displays (incl. the notebook display)

Max. resolutions supported

Dock Connectors
Technical limitations

Docking station model #3

Total number of supported displays (incl. the notebook display)

Max. resolutions supported

Dock Connectors
Technical limitations

HP Thunderbolt 120W G4 Dock

4

Quad 4K @60Hz

Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode

2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode

Maximum resolution and display support is dependent on the maximum capability of the notebook.

Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

HP Thunderbolt 280W G4 Dock

4

Quad 4K @60Hz

Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode

2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode

Maximum resolution and display support is dependent on the maximum capability of the notebook.

Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

HP USB-C Dock G5

3

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)

1xHDMI, 2xDP

Maximum resolution and display support is dependent on the maximum capability of the notebook.

Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.

Options and Accessories (Sold separately and availability may vary by country)

Three maximum displays supported are two 5K@ 30 Hz on DP ports

plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode

The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI

port.

Docking station model #4

Total number of supported displays (incl. the notebook

display)

Max. resolutions supported

Dock Connectors

Technical limitations

HP USB-C/A Universal Dock G2

3

3

Dual 4K @ 60Hz Single 5K @ 60Hz 1xHDMI. 2xDP

Maximum resolution and display support is dependent on the

maximum capability of the notebook.

The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1

connection from the host.

Docking station model #5

Total number of supported displays (incl. the notebook

display)

Max. resolutions supported

HP USB-C G5 Essential Dock

For hosts that support DisplayPort 1.4 with Display Stream

Compression: 3x FHD @ 60 Hz 3x QHD @ 60 Hz 3x 4K @ 60 Hz

For hosts that support DisplayPort 1.3/1.4:

3x FHD @ 60 Hz 3x QHD @ 60 Hz 2x 4K @ 60 Hz 1 x HDMI, 2 x DP

Dock Connectors
Technical limitations

Technical limitationsVideo resolution depends on the capability of the host machine. This

dock provides up to 65W of power delivery to the host machine.

Туре	Description	Part Number
Audio	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
	HP 365 BT Speaker	567D3AA#ACJ
Video	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K USB-A STR Webcam	695J5AA
Cases	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
Digital Pen	HP Active RECHBL G3 Moonracer 2.0 Pen	6SG43AA

Options and Accessories (Sold separately and availability may vary by country)

Docking	HP USB-C 120W G5 Dock	5TW10AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock	4J0G4AA
Hub	HP 4K USB-C Multiport Hub	6G842AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
Keyboard/Combo	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 355 Compact Multi-Device BT Keyboard	692S9AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 155 Wired Mouse and Keyboard Combo	5B8C0AA#ACJ
	HP 225 Antimicrobial Wired Mouse and Keyboard Combo	286K3AA#AB2
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 155 USB-A Wired Mouse	5B8B7AA#ACJ
	HP 235 Wireless 2.4GHz Slim Wireless Mouse	4E407AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse	3B4Q5AA
	HP 715 Rechargeable Multi-Device Bluetooth 5.0 + Wireless 2.4GHz Bluetooth Mouse	6E6F0AA
	HP 925 Ergonomic Vertical Bluetooth 5.0 + Wireless 2.4GHz Wireless Mouse	6H1A5AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB Premium Wireless Mouse	1JR31AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W GaN USB-C Laptop Charger	600Q7AA
	HP 65W USB-C Laptop Charger	671R3AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA

Options and Accessories (Sold separately and availability may vary by country)

Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	HP Combination Nano Cable Lock	63B28AA
	HP Essential Combination Nano Cable Lock	63B31AA

Change Log

Date of change:	Version History:		Description of change:
March 30, 2023	V1 to V2	Added	Environmental Data
April 6. 2023	V2 to V3	Updated	DisplayPort TM in Display section
•	V3 to V4	'	

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